

#### AM / FM - PLL

#### **Description**

The U4283BM is an integrated circuit in BICMOS technology for frequency synthesizer. It performs all the functions of a PLL radio tuning system and is controlled by  $I^2C$  bus. The device is designed for all frequency

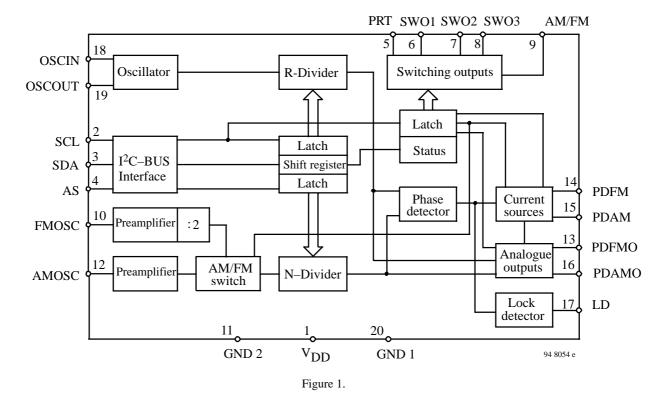
synthesizer applications of radio receivers, as well as RDS (Radio Data System) applications.

#### **Features**

- Reference oscillator up to 15 MHz
- Two programmable 16 bit dividers adjustable from 2 to 65535
- Fine tuning steps: AM  $\ge 1 \text{ kHz}$ FM  $\ge 2 \text{ kHz}$

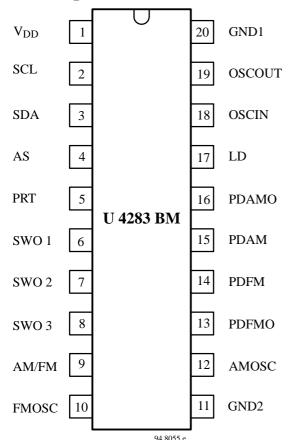
- Three programmable switching outputs (open drain up to 20 V)
- Few external component requirements due to integrated loop-transistor for AM/FM
- High signal/ noise ratio

#### **Block Diagram**





#### **Pin Description**



Pin	Symbol	Function
1	$V_{DD}$	Supply voltage
2	SCL	I <sup>2</sup> C bus clock
3	SDA	I <sup>2</sup> C bus data
4	AS	Address selection
5	PRT	Switching port
6	SWO 1	Switching output 1
7	SWO 2	Switching output 2
8	SWO3	Switching output 3
9	AM/FM	Switching output AM/FM
10	FMOSC	FM oscillator input
11	GND 2	Ground 2 (analogue)
12	AMOSC	AM oscillator input
13	PDFMO	FM analogue output
14	PDFM	FM current output
15	PDAM	AM current output
16	PDAMO	AM analogue output
17	LD	Lock detector
18	OSCIN	Oscillator input
19	OSCOUT	Oscillator output
20	GND 1	Ground 1 (digital)

#### **Functional Description**

The U4283BM is controlled via the 2-wire I<sup>2</sup>C bus. For programming there are one module address byte, two subaddress bytes and five data bytes.

The module address contains a programmable address bit A 1 which with address select input AS (pin 4) makes it possible to operate two U4283BM-B in one system. If bit A 1 is identical with the status of the address select input AS, the chip is selected.

The subaddress determines which one of the data bytes is transmitted first. If subaddress of R-divider is transmitted, the sequence of the next data bytes is DB 0 (Status), DB 1 and DB 2.

If subaddress of N-divider is transmitted, the sequence of the next data bytes is DB 3 and DB 4. The bit organisation of the module address, subaddress and 5 data bytes are shown in figure 2 Each transmission on the  $I^2C$  bus begins with the "START"-condition and has to be ended by the "STOP"-condition (see figure 3).

The integrated Circuit U 4283 BM has two separate inputs for AM and FM oscillator. Pre-amplified AM signal is directed to the 16 bit N-divider via AM/FM switch, whereas (pre-amplified) FM signal is first divided by a fixed prescaler (:2). AM/FM switch is controlled by software. Tuning steps can be selected by 16 bit R-divider. Further there is a digital memory phase detector. There are two separate current sources for AM and FM amplifier (charge pump) as given in electrical characteristics. It allows independent adjustment of gain, whereby providing high current for high speed tuning and low current for stable tuning.



# **Bit Organization**

	MSB							LS
Module address	1	1	0	0	1	0	0/1	0
	A7	A6	A5	A4	A3	A2	A1	A(
Subaddress (R-divider)	X	X	X	X	0	1	X	X
Subaddress (N-divider)	X	X	X	X	1	1	X	X
	MSB							LS
Data byte 0 (Status)	PRT	SWO1	SWO2	SWO3	AM/	PD	PD	PI
					FM	ANA	POL	CU
	D7	D6	D5	D4	D3	D2	D1	D(
Data byte 1	215			R-di	vider			28
,								
Data byte 2	27			R-div	vider			20
•	<b>'</b>	•						-
Data byte 3	215	N-divider					28	

	LOW	HIGH
AM/FM	FM-operation	AM-operation
PD - ANA	PD analogue	TEST
PD - POL	Negative polarity	Positive polarity
PD - CUR	Output current 2	Output current 1

Figure 2.

# **U4283BM**



## **Transmission Protocol**

	MSB	LSB										
S	Add	ress	Α	Subaddress	A	Data 0	Α	Data 1	Α	Data 2	Α	P
	A7	A0		R-divider								

	MSB	LSB								
S	Addr A7	ess A0	A	Subaddress N-divider	A	Data 3	A	Data 4	A	P
	117	710		TV dividei				A		

 $S = Start \qquad P = Stop \qquad A = Acknowledge$ 

Figure 3.

## **Absolute Maximum Ratings**

Par	ameters	Symbol	Value	Unit
Supply voltage	Pin 1	$V_{\mathrm{DD}}$	-0.3 to +6	V
Input voltage	Pins 2, 3, 4, 10, 12, 18, 19	V <sub>I</sub>	-0.3 to V <sub>DD</sub> +0.3	V
Output current	Pins 3, 5, 6, 7, 8, 9	I <sub>O</sub>	-1 to +5	mA
Output drain voltage	Pins 6, 7, 8, 9	V <sub>OD</sub>	20	V
Output voltage	Pins 13, 16	V <sub>AO</sub>	15	V
Output current	Pins 13, 16	$I_{AO}$	−1 to +20	mA
Ambient temperature range		T <sub>amb</sub>	-25 to +85	°C
Storage temperature range		T <sub>stg</sub>	-40 to +125	°C
Junction temperature		Tj	125	°C
Electrostatic handling (MIL	Standard 883C)	$\pm V_{ESD}$	2000	V

#### **Thermal Resistance**

Parameters	Symbol	Value	Unit	
Junction ambient	$R_{thJA}$	160	K/W	



#### **Electrical Characteristics**

 $V_{DD} = 5$  V,  $T_{amb} = 25$ °C, unless otherwise specified.

Parameters	Test Conditions / Pins	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	Pin 1	$V_{\mathrm{DD}}$	4.5	5.0	5.5	V
Quiescent	Pin 1					
supply current		$I_{\mathrm{DD}}$		6.0	11.6	mA
FM Input Sensitivity, R <sub>G</sub> =	50 Ω FMOSC					
$f_i = 70 \text{ to } 120 \text{ MHz}$	Pin 10	V <sub>SFM</sub>	25			mV
$f_i = 120 \text{ to } 130 \text{ MHz}$	Pin 10	V <sub>SFM</sub>	50			mV
AM Input Sensitivity, R <sub>G</sub> =	50 Ω AMOSC					
$f_i = 0.5 \text{ to } 35 \text{ MHz}$	Pin 12	$V_{SAM}$	25			mV
<b>Oscillator Input Sensitivity,</b>	$R_G = 50 \Omega \text{ OSCIN}$				•	•
$f_i = 0.1 \text{ to } 15 \text{ MHz}$	Pin 14	V <sub>SOSC</sub>	100			mV
Switching Output SWO 1, S	WO 2, SWO3, AM/FM (Ope					
Output voltage	Pins 6, 7, 8, 9					
LOW	$I_L = 1 \text{ mA}$	$V_{SWOL}$		200	400	mV
LOW	$I_L = 0.1 \text{ mA}$	$V_{SWOL}$		20	100	mV
Output leakage current	Pins 6, 7, 8, 9	_			400	
HIGH	V5, V6 = 20 V	$I_{OHL}$			100	nA
Lock detector output (Open	Drain)	T	1		ı	<u> </u>
Output voltage					0.4	**
LOW	I = 3  mA				0.4	V
Switching output PRT	Pin 5		1		ı	
Output voltage	T 1 A	X.7	X7 0.4			***
HIGH LOW	$I_L = 1 \text{ mA}$	V <sub>OH</sub>	$V_{DD}$ $-0.4$		0.4	V V
LOW	$ \begin{aligned} I_{L} &= 1 \text{ mA} \\ I_{L} &= 0.1 \text{ mA} \end{aligned} $	$egin{array}{c} V_{ m OL} \ V_{ m OL} \end{array}$			0.4	V
Phase Detector PDFM	1L = 0.1 m/x	VOL			0.1	•
	Pin 14	1 T	400	500	600	
Output current 1 Output current 2	Pin 14 Pin 14	$\pm I_{PDFM}  \pm I_{PDFM}$	100	125	150	μA μA
Phase Detector PDAM	111114	_ <u>_ 1PDFM</u>	100	123	130	μΑ
Output current 1	Pin 15	+ Inn	75	100	125	μΑ
Output current 2	Pin 15	$\pm I_{PDAM}$ $\pm I_{PDAM}$	20	25	30	μΑ
Analogue Output PDFMO,		- PDAM	20		30	pu 1
Saturation voltage	I = 15 mA					
Saturation voltage	Pins 13, 16	V <sub>sat</sub>		270	400	mV
Leakage current	Pins 13, 16	I <sub>LEAK</sub>			1	μΑ
I <sup>2</sup> C Bus SCL, SDA, AS	1 1115 13, 10	LEAR	1		1 1	1 6.7.
Input voltage	Pin 2, 3, 4	V <sub>iBUS</sub>				
HIGH	1 111 2, 3, 4	, 1RO2	3.0		V <sub>DD</sub>	V
LOW			0		1.5	V
Output voltage	$I_{SDA} = 3 \text{ mA}$ Pin 3					
Acknowledge LOW	55.1	$V_{O}$			0.4	V
Clock frequency	Pin 2	$f_{SCL}$			100	kHz
Rise time SDA, SCL	Pin 2, 3	$t_{\rm r}$			1	μs



Parameters	Test Conditions / Pins	Symbol	Min.	Тур.	Max.	Unit
Fall time SDA, SCL	Pin 2, 3	$t_{\mathrm{f}}$			300	ns
Period of SCL	Pin 2					
HIGH		t <sub>H</sub>	4.0			μs
LOW		tL	4.7			μs
Setup Time						
Start condition		t <sub>sSTA</sub>	4.7			μs
Data		$t_{sDAT}$	250			ns
Stop condition		t <sub>sSTOP</sub>	4.7			μs
Time the bus must be free						
before a new transmission		t <sub>wSTA</sub>	4.7			μs
can be started						
Hold time						
Start condition		t <sub>hSTA</sub>	4.0			μs
DATA		t <sub>hDAT</sub>	0			μs

# **Bus Timing**

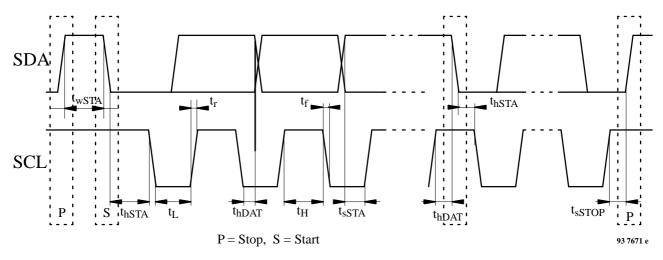


Figure 4.

#### The following hints are recommended:

- $C_3 = 100 \text{ nF}$  should be very close to Pin 1 ( $V_{DD}$ ) and Pin 20 (GND1)
- GND2 (Pin 10 analogue ground) and GND 1
   (Pin 20 digital ground ) must be connected according to figure 6
- 4 MHz quartz must be very close to Pin 18 and Pin 19
- Components of the charge pump (C<sub>1</sub>/R<sub>1</sub> for AM and C<sub>2</sub>/R<sub>2</sub> for FM) should be very close to Pin 15 with respect to Pin 14.



## **Application Circuit**

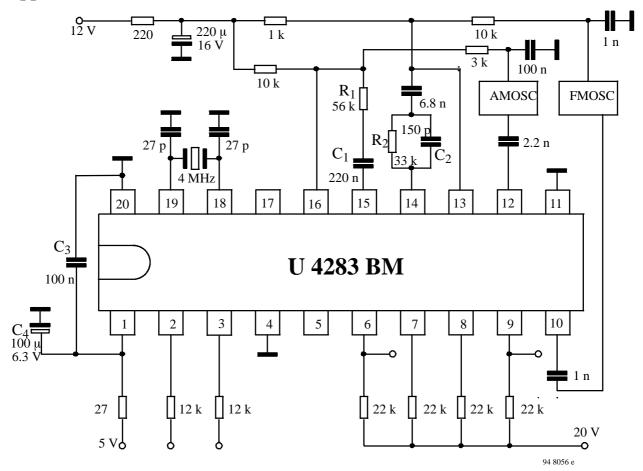


Figure 5.

# **PCB-Layout**

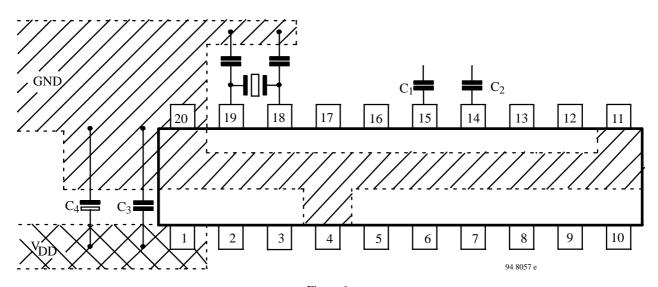


Figure 6.

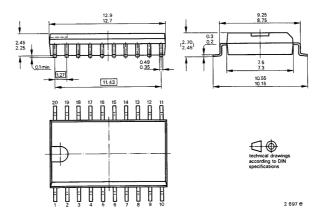


# **Ordering and Package Information**

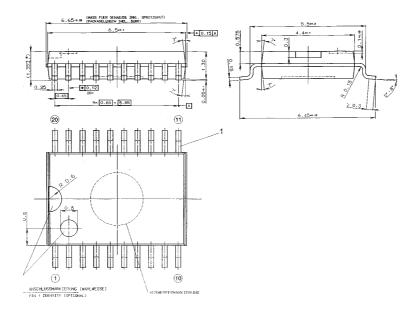
Extended Type Number	Package	Remarks
U4283BM-BFP	SO20 plastic	
U4283BM-BFPG3	SO20 plastic	Taping according to IEC-286-3
U4283BM-BFS	SSO20 plastic	

## **Dimensions in mm**

Package: SO20



Package: SSO20





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- 1. Meet all present and future national and international statutory requirements.
- Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

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- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

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